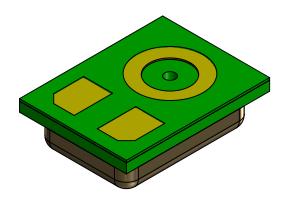


# "SPA Zero Height" SiSonic<sup>™</sup> Microphone Specification With Maximum RF Protection - *Halogen Free*





Knowles Acoustics 1151 Maplewood Drive Itasca, IL 60143





#### 1. DESCRIPTION AND APPLICATION

1.1 DESCRIPTION "SPA" Surface Mount Silicon Microphone with

Maximum RF Protection - Halogen Free

1.2 APPLICATION Consumer electronics

#### 2. PART MARKING

Identification Number Convention

S 1 2 3

4 5 6 7

S: Manufacturing Location
"S" - Knowles Electronics Suzhou
Suzhou, China

"No Alpha Character" - Knowles Electronics Itasca, IL USA

"E" - Engineering Samples

Digits 1-7: Job Identification Number

### 3. TEMPERATURE RANGE

3.1 Operating Temperature Range: -40°C to +100°C

3.2 Storage Temperature Range: -40°C to +100°C

#### 4. ABSOLUTE MAXIMUM RATINGS

| Parameter                                 | Absolute Maximum Rating    | Unit |
|---|----------------------------|------|
| Supply Voltage, V <sub>DD</sub> to Ground | -0.5, +5.0                 | V    |
| OUT to Ground                             | -0.3, V <sub>DD</sub> +0.3 | ٧    |
| Input Current to Any Pin                  | ±5                         | mΑ   |

Stresses at these Absolute Maximum Ratings may cause permanent damage to the device. These are stress ratings only. The device may not function when operated at these or any other conditions beyond those indicated under "Acoustic & Electrical Specifications". Exposure beyond those indicated under "Acoustic & Electrical Specifications" for extended periods may affect device reliability.





## 5. ACOUSTIC & ELECTRICAL SPECIFICATIONS

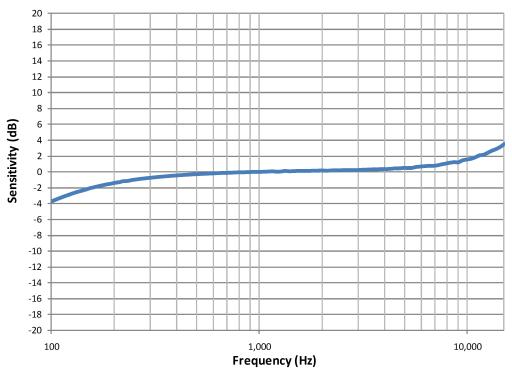
TEST CONDITIONS: 23  $\pm$ 2°C, 60-70% R.H.,  $V_{DD}(min) \le V_{DD} \le V_{DD}(max)$ , no load, unless otherwise specified

| Parameter                        | Symbol Condition |  | Limits |           | Unit      |        |
|----------------------------------|------------------|--|--------|-----------|-----------|--------|
| raidifferei                      | Syllibol         | Condinon                                 | Min.   | Nom.      | Max.      | Orini  |
| Supply Voltage <sup>1</sup>      | $V_{DD}$         |  | 1.5    |           | 3.6       | V      |
| Current Consumption <sup>1</sup> | I <sub>DD</sub>  |  |        |           | 250       | μA     |
| Directivity                      |                  |  |        | Omni-di   | rectional |        |
| Sensitivity <sup>1</sup>         | S                | 94 dB SPL @ 1kHz                         | -41    | -38       | -35       | dBV/Pa |
| Signal to Noise Ratio            | SNR              | 94 dB SPL @ 1kHz, A-weighted             |        | 62        |           | dB(A)  |
| Output Impedance                 |                  | @ lkHz                                   |        |           | 400       | Ω      |
| Total Harmonic                   | TUD+VI           | 100 dB SPL @ 1kHz, $R_{load} > 3k\Omega$ |        |           | 1         | %      |
| Distortion + Noise               | אדטחון           | 115 dB SPL @ 1kHz, $R_{load} > 3k\Omega$ |        |           | 10        | %      |
| Polarity                         |                  | Increasing sound pressure                | Incre  | easing ou | ıtput vol | tage   |

<sup>1 100%</sup> tested

## 6. FREQUENCY RESPONSE CURVE

#### **TYPICAL FREE FIELD RESPONSE NORMALIZED TO 1kHz**

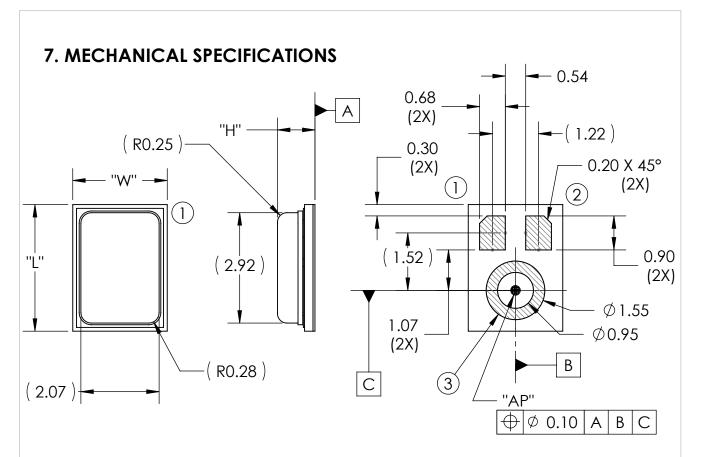




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| ITEM       | DIMENSION | TOLERANCE     | UNITS |
|------------|-----------|---------------|-------|
| LENGTH (L) | 3.35      | ±0.075        | mm    |
| WIDTH (W)  | 2.50      | ±0.075        | mm    |
| HEIGHT (H) | 0.98      | ±0.100        | mm    |
| ACOUSTIC   | Ø0.25     | 10.005/.0.050 | no no |
| PORT (AP)  | Ø0.25     | +0.025/-0.050 | mm    |

| PIN OUTPUT |                          |  |
|------------|--------------------------|--|
| PIN#       | FUNCTION                 |  |
| 1          | POWER (V <sub>DD</sub> ) |  |
| 2          | OUTPUT                   |  |
| 3          | GROUND                   |  |

#### Note:

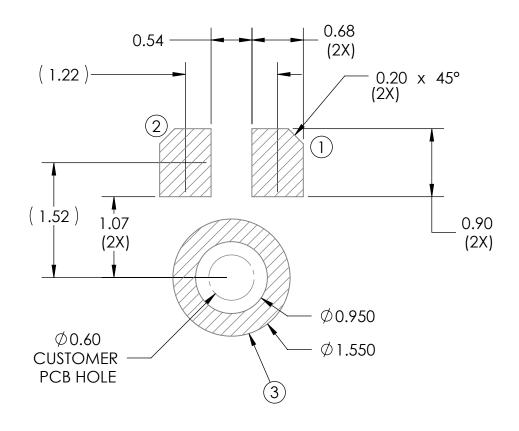
Dimensions are in milimeters unless otherwise specified.

Tolerance  $\pm 0.15$ mm unless otherwise specified.





### 8. RECOMMENDED CUSTOMER LAND PATTERN



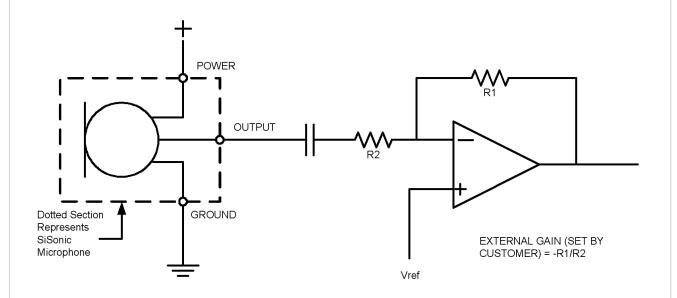
### 9. RECOMMENDED SOLDER STENCIL PATTERN

N/A





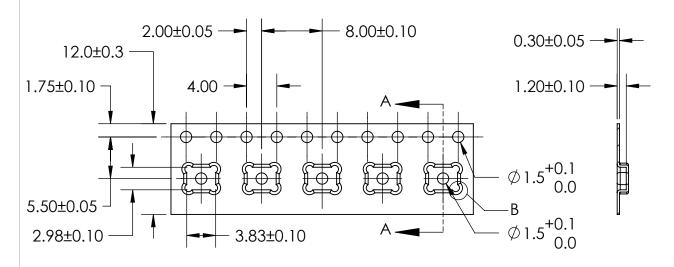
## 10. RECOMMENDED INTERFACE CIRCUIT

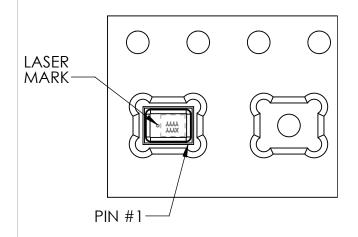


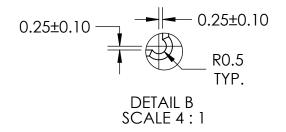




### 11. PACKAGING DETAIL







**COMPONENT ORIENTATION** 

| MODEL NUMBER  | SUFFIX | REEL     | QUANTITY |
|---------------|--------|----------|----------|
| MODEL NUMBER  | SUFFIX | DIAMETER | PER REEL |
| SPA2410LR5H-B | -8     | 13"      | 5,900    |

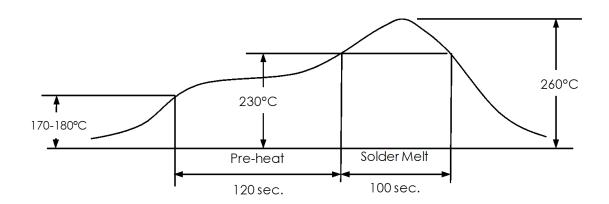
| TAPE & REEL | PER EIA-481   |
|-------------|---|
| II ABEI     | LABEL APPLIED TO EXTERNAL PACKAGE & DIRECT TO REEL. |

#### Note:

Dimensions are in milimeters unless otherwise specified.



### 12. SOLDER FLOW PROFILE



| Stage       | Temperature Profile | Time (maximum) |
|-------------|---------------------|----------------|
| Pre-heat    | 170 ~ 180°C         | 120 sec.       |
| Solder Melt | Above 230°C         | 100 sec.       |
| Peak        | 260°C maximum       | 30 sec.        |

#### 13. ADDITIONAL NOTES

- (A) Shelf life: Twelve (12) months when devices are to be stored in factory supplied, unopened ESD moisture sensitive bag under maximum environmental conditions of 30°C, 70% R.H.
- (B) MSL (moisture sensitivity level) Class 2a.
- (C) <u>Do not pull a vacuum</u> over port hole of the microphone. Pulling a vacum over the port hole can damage the device.
- (D) Do not board wash after the reflow process. Board washing and cleaning agents can damage the device. Do not expose to ultrasonic processing or cleaning.
- (E) <u>Do not brush board after the reflow process.</u> Brushing the board with/without solvents can damage the device.
- (F) <u>Do not insert any object in port hole</u> of device at any time as this can damage the device.
- (G) Number of reflow Recommend no more than 3 cycles.



Sheet 8 of 10



## 14. RELIABILITY SPECIFICATIONS

Note: After test conditions are performed, the sensitivity of the microphone shall not deviate more than 3dB from its initial value.

| Test   | Description   |
|--|---|
| Thermal Shock  | 100 cycles of air-air thermal shock from -40°C to           |
| momal one ex   | +125°C with 15 minute soaks. (IEC 68-2-4)                   |
| High Temperature   | +105°C environment for 1,000 hours. (IEC 68-2-2 Test        |
| Storage  | Ba)   |
| Low Temperature  | -40°C environment for 1,000 hours. (IEC 68-2-2 Test Aa)     |
| Storage  | -40 C environment for 1,000 hoors. (IEC 60-2-2 fest Adj     |
| High Temperature Bias  | +105°C environment while under bias for 1,000 hours.        |
| Ingritemperatore das   | (IEC 68-2-2 Test Ba)  |
| Low Tomporature Pias   | -40°C environment while under bias for 1,000 hours.         |
| Low Temperature Bias   | (IEC 68-2-2 Test Aa)  |
| Temperature / Humidity +85°C/85% R.H. environment while under bias for |   |
| Bias   | hours. (JESD22-A101A-B)                                     |
|  | 4 cycles lasting 12 minutes from 20 TO 2,000 Hz in X, Y     |
| Vibration  | and Z direction with peak acceleration of 20g. (MIL         |
|  | 883E, Method 2007.2, A)                                     |
|  | 3 discharges at +/-8kV direct contact to lid when unit      |
| Electrostatic Discharge  | is grounded (IEC 61000-4-2) and 3 discharges at +/-2kV      |
|  | direct contact to I/O pins. (MIL 883E, Method 3015.7)       |
| Reflow   | 5 reflow cycles with peak temperature of +260°C.            |
|  | 3 pulses of 10,000g in the X, Y and Z direction. (IEC 68-2- |
| Mechanical Shock   | 27, Test Ea)  |





### 15. SPECIFICATION REVISIONS

| Revision | Detailed Specification Changes   | Date     |  |
|----------|--|----------|--|
| Α        | Specification Release (MD) (C10111056)   | 4-8-10   |  |
| В        | Update tables sheets 2, 3, 4, 6, 7. Misc cleanup not changing content. (C10112107) | 10-22-10 |  |
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